TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS II)

TPC6106

Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance: $RDS(ON) = 58 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance: $|Y_{fs}| = 5.5 \text{ S (typ.)}$
- Low leakage current: $IDSS = -10 \mu A (max) (VDS = -40 V)$
- Enhancement model: $V_{th} = -0.8$ to -2.0 V $(V_{DS} = -10$ V, $I_D = -1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Character	ristics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	-40	V
Drain-gate voltage (R	_{GS} = 20 kΩ)	V_{DGR}	-49	\checkmark
Gate-source voltage		V _{GSS}	±20	> v
Drain current	DC (Note 1)	I _D	3.9	Α
	Pulse (Note 1)	I _{DP}	-15.6	A
Drain power dissipation	on (t = 5 s) (Note 2a)	PD	2.2	(w
Drain power dissipation	on (t = 5 s) (Note 2b)	PD	0.7	W
Single pulse avalanch	e energy (Note 3)	EAS	1.7	mJ
Avalanche current		(I _{AR}))	-1.9	A
Repetitive avalanche	energy (Note 4)	EAR	0.22	m
Channel temperature		/) T _{ch}	150	∵°C
Storage temperature i	range	T _{stg}	-55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

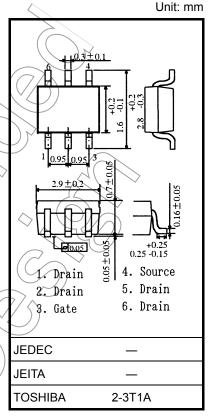
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient $(t = 5 \text{ s})$ (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W

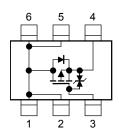
Note: (Note 1), (Note 2), (Note 3), (Note 4) and (Note 5): See the next page.

This transistor is an electrostatic-sensitive device. Please handle with caution.



Weight: 0.011 g (typ.)

Circuit Configuration



Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μΑ	
Drain cut-off curr	ent	I _{DSS}	V _{DS} = -40 V, V _{GS} = 0 V	_	_	-10	μА	
Drain-source breakdown voltage		V _{(BR) DSS}	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$ -40		_	_	V	
		V _{(BR)DSX}	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	25	_	_	V	
Gate threshold voltage		V _{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	0.85) >_	-2.0	V	
Drain-source ON resistance		R _{DS} (ON)	$V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$) 	90	120	mΩ	
		R _{DS} (ON)	$V_{GS} = -10 \text{ V}, I_D = -1.9 \text{ A}$	\rightarrow	58	75		
Forward transfer admittance		Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -1.9 \text{ A}$	2.7	5.5	_	S	
Input capacitance		C _{iss}		_	460	_		
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	85	_	pF	
Output capacitance		Coss			(140	\nearrow		
	Rise time	t _r	0 V 7	-(7	> _		
0 " 1 " "	Turn-on time	t _{on}	VGS O VOUT			_		
Switching time	Fall time	t _f	R = 10.		33	_	ns	
	Turn-off time	t _{off}	$V_{DD} \simeq -20 \text{ V}$ Duty $\leq 1\%$, $t_W = 10 \text{ µs}$) $-$	86	_		
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -32 \text{ V}, V_{DS} = -10 \text{ V},$	_	12		_	
Gate-source charge		Qgs	$I_D = -3.9 \text{ A}$	_	9	_	nC	
Gate-drain ("miller") charge		Qgd		_	3	_		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Charact	reristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	IDRP		ı	ı	-15.6	Α
Forward voltage	(diode)	V _{DSF}	$DR = -3.9 \text{ A}, V_{GS} = 0 \text{ V}$			1.2	V

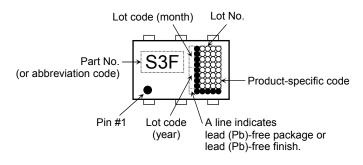
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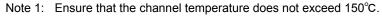
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25.4 × 25.4 × 0.8 (Unit: mm)

(b)

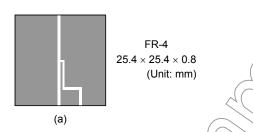
Marking (Note 5)

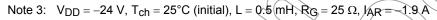




Note 2: (a) Device mounted on a glass-epoxy board (a) (t = 5 s)

(b) Device mounted on a glass-epoxy board (b) (t = 5 s)



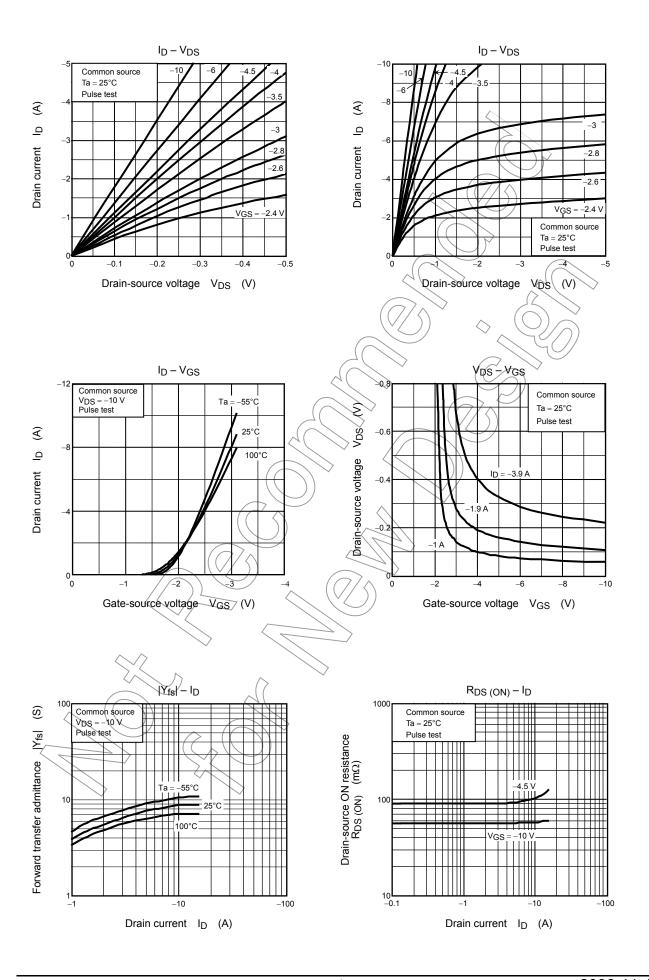


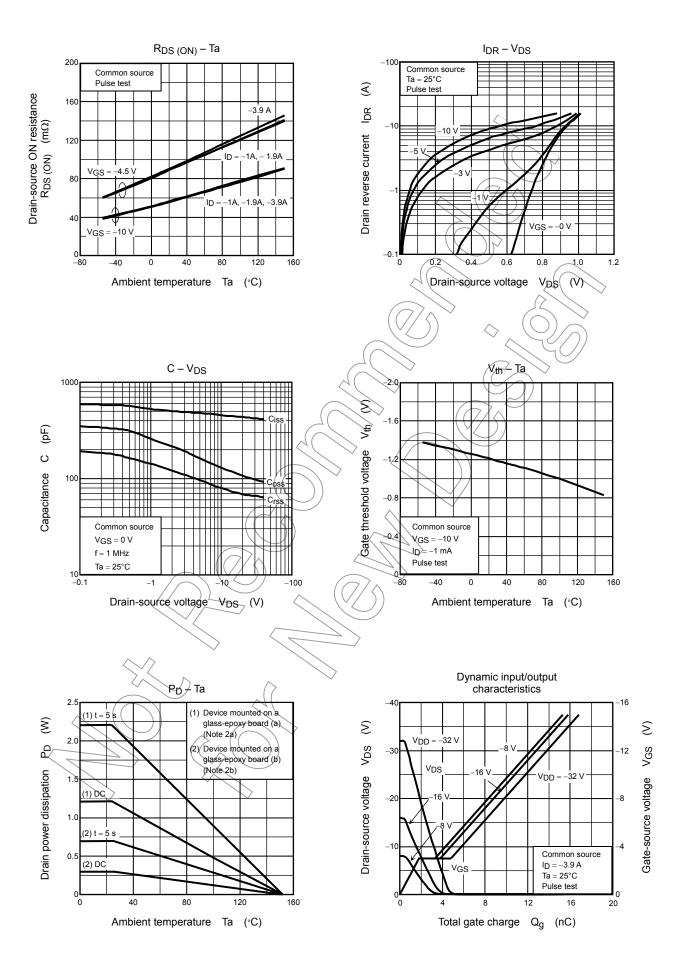
Note 4: Repetitive rating pulse width limited by maximum channel temperature

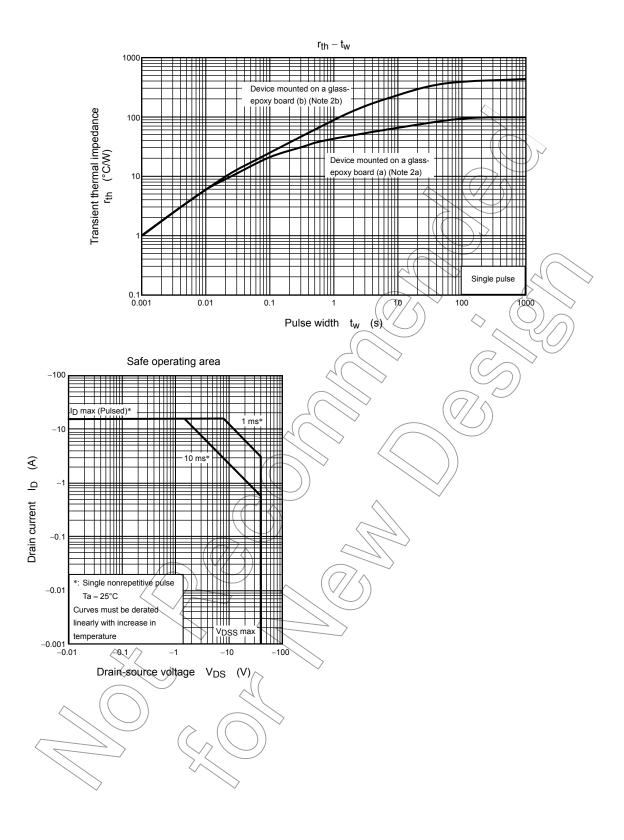
Note 5: • on the lower left of the marking indicates Pin 1.



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